

FJ. F.

PIN 1

Ø0.45 [Ø0.018]

(6 PLS.)

B C D E

12

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11 7 4 2 1 10 5

DIG 1

G DP1

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3

PIN 6

2.54 [0.100]

(5 PLS.)

DIG 2

G DP2

9

COMMON ANODE

B C D E F

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8

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DIG 3

G DP3

B

77

32.20 [1.268] -

B C D E

ELECTRO-OPTICAL CHARACTERISTICS TA=25°C If=10mA								
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND			
PEAK WAVELENGTH		635 (RED)		nm				
FORWARD VOLTAGE		2.0	2.5	٧f				
REVERSE VOLTAGE	5.0			۷r	Aµ000 I r			
AXIAL INTENSITY		5000		μcd	lf=10mA			
EMITTED COLOR:	RED							
FACE COLOR:	GRAY							
SEGMENT COLOR:	MILKY	WHITE DIFFUS	SED					

REV.

С

DATE

5.1.97

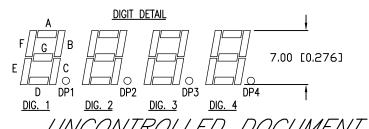
10.2.98

8.22.01

## LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS	
PEAK FORWARD CURRENT*	150	mA	
STEADY CURRENT	30	mA	
POWER DISSIPATION	105	mW	
DERATE FROM 25°C	- 1.2	mW/*C	
OPERATING, STORAGE TEMP.	- 30 TO + 85	•C	
SOLDERING TEMP.	+ 260	•C	
2.0mm FROM BODY		3 SEC. MAX	
* t<10uS			

\* t<10µS



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= DECIMAL PRECISION MAX.= +0.00 -DECIMAL PRECISION -DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= DECIMAL PRECISION MAX.= +0.00							
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RE	0.28" FOUR DIGIT SEVEN SEGMENT DISPLAY, D, GRAY FACE WITH MILKY WHITE DIFFUSED SEGMENTS.	RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.	DRAWN BY: ct		APPROVED BY:		

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DEF

DIG 4

G DP4

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